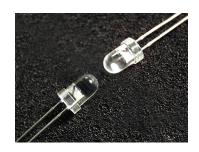
Cree® 5mm Round LED C503B-WAN



PRODUCT DESCRIPTION

Round LEDs offer superior light output for excellent readability in sunlight and dependable performance. They provide extremely stable light output over long periods of time.

These lamps are made with an advanced optical grade epoxy offering superior high temperature and high moisture resistance performance in lighting and illumination applications.

FEATURES

- Size (mm): 5
- Color Temperatures(K): Cool White:Min . (4600) / Typical (9000)
- Luminous Intensity (mcd)
 C503B-WAN (20150-46100)
- Viewing angle: 15 degree
- Lead-Free
- RoHS Compliant

APPLICATIONS

- Torch
- Channel Letter
- Retail Display Lighting



ABSOLUTE MAXIMUM RATINGS $(T_A = 25^{\circ}C)$

Items	Symbol	Absolute Maximum Rating	Unit	
Forward Current	$I_{_{\rm F}}$	25	mA	
Peak Forward Current Note	${\rm I}_{\sf FP}$	100	mA	
Reverse Voltage	$V_{_{\mathrm{R}}}$	5	V	
Power Dissipation	$P_{_{\rm D}}$	100	mW	
Operation Temperature	T_{opr}	-40 ~ +95	°C	
Storage Temperature	T_{stg}	-40 ~ +100	°C	
Lead Soldering Temperature	T_{sol}	Max. 260° C for 3 sec. max. (3 mm from the base of the epoxy bulb)		

Note: Pulse width ≤ 0.1 msec, duty $\leq 1/10$.

TYPICAL ELECTRICAL & OPTICAL CHARACTERISTICS $(T_A = 25^{\circ}C)$

Characteristics	Symbol	Condition	Unit	Minimum	Typical	Maximum
Forward Voltage	$V_{\scriptscriptstyle F}$	$I_F = 20 \text{ mA}$	V		3.2	4.0
Reverse Current	I_R	$V_R = 5 V$	μA			100
Luminous Intensity	I_{\vee}	$I_F = 20 \text{ mA}$	mcd	20150	34000	
Chromaticity Coordinates	x	$I_F = 20 \text{ mA}$			0.2895	
	У	$I_F = 20 \text{ mA}$			0.2905	
50% Power Angle	201/2	$I_F = 20 \text{ mA}$	deg		15	

Note: Continuous reverse voltage can cause LED damage.



INTENSITY BIN LIMIT ($I_F = 20 \text{ mA}$)

Cool White

Bin Code	Min. (mcd)	Max. (mcd)
Bb	20150	23500
Ca	23500	28200
Cb	28200	32900
Da	32900	39500
Db	39500	46100

• Tolerance of measurement of luminous intensity is ±15%

VF BIN LIMIT ($I_F = 20 \text{ mA}$)

Cool White

Bin Code	Min. (V)	Max. (V)
27	2.8	3.0
28	3.0	3.2
29	3.2	3.4
2a	3.4	3.6
2b	3.6	3.8
2c	3.8	4.0

• Tolerance of measurement of VF is ± 0.05 V.



COLOR BIN LIMIT ($I_F = 20 \text{ mA}$)

Cool White

Bin Code	Sub- bin	x	У	
	Wa	0.2545	0.2480	
		0.2633	0.2410	
		0.2545	0.2245	
		0.2450	0.2290	
		0.2633	0.2410	
	Wb	0.2720	0.2340	
	VVD	0.2640	0.2200	
VA/1		0.2545	0.2245	
W1		0.2545	0.2480	
	\\/-	0.2640	0.2670	
	Wc	0.2720	0.2575	
		0.2633	0.2410	
	Wd	0.2633	0.2410	
		0.2720	0.2575	
		0.2800	0.2480	
		0.2720	0.2340	
	We	0.2640	0.2670	
		0.2735	0.2860	
		0.2808	0.2740	
		0.2720	0.2575	
		0.2720	0.2575	
	Wf	0.2808	0.2740	
	VVI	0.2880	0.2620	
W2		0.2800	0.2480	
VV Z		0.2735	0.2860	
	Wg	0.2830	0.3050	
		0.2895	0.2905	
		0.2808	0.2740	
	Wh	0.2808	0.2740	
		0.2895	0.2905	
		0.2960	0.2760	
		0.2880	0.2620	

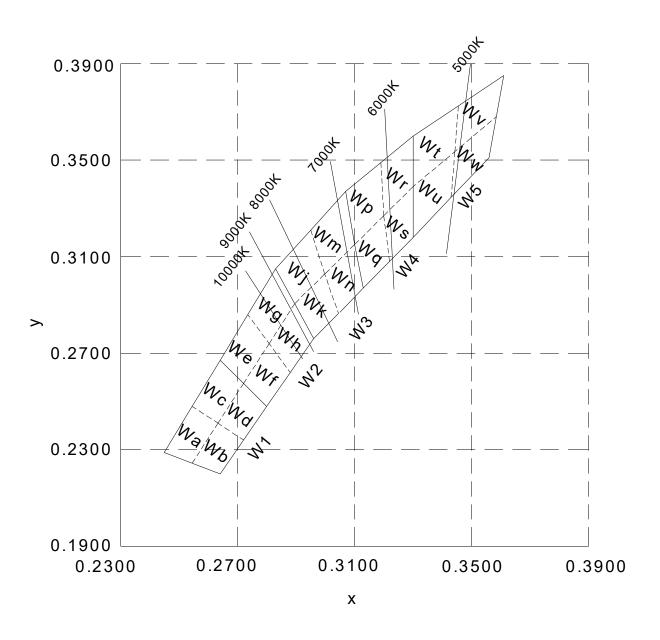
D.:	C. I		
Bin Code	Sub- bin	x	У
	Wj	0.2830	0.3050
		0.2950	0.3210
		0.2998	0.3028
		0.2895	0.2905
		0.2895	0.2905
	Wk	0.2998	0.3028
	VVK	0.3045	0.2865
W3		0.2960	0.2760
VVS		0.2950	0.3210
	Wm	0.3070	0.3370
	VVIII	0.3100	0.3150
		0.2998	0.3028
		0.2998	0.3028
	Wn	0.3100	0.3150
	VVII	0.3130	0.2970
		0.3045	0.2865
		0.3070	0.3370
	Wn	0.3185	0.3485
	Wp	0.3200	0.3270
		0.3100	0.3150
		0.3100	0.3150
	Wq	0.3200	0.3270
	VVY	0.3215	0.3075
W4		0.3130	0.2970
VV-4		0.3185	0.3485
	Wr	0.3300	0.3600
	VVI	0.3300	0.3390
		0.3200	0.3270
		0.3200	0.3270
	Ws	0.3300	0.3390
	VVS	0.3300	0.3180
		0.3215	0.3075

Bin	Sub-	x	v
Code	bin	^	У
	Wt	0.3300	0.3600
		0.3455	0.3725
	VVL	0.3443	0.3535
		0.3300	0.3390
		0.3300	0.3390
	Wu	0.3443	0.3535
		0.3430	0.3345
W5		0.3300	0.3180
VVO	Wv	0.3455	0.3725
		0.3610	0.3850
		0.3585	0.3680
		0.3443	0.3535
		0.3443	0.3535
	Ww	0.3585	0.3680
		0.3560	0.3510
		0.3430	0.3345

• Tolerance of measurement of the color coordinates is ± 0.01 .



CIE CHROMATICITY DIAGRAM





ORDER CODE TABLE*

Color Kit Number		Viewing Angle	Luminous Intensity (mcd)		Color Bin Code	
Color	Kit Number	Viewing Angle	Min.	Max.	Color Bin Code	Package
Cool White	C503B-WAN-CBbDb151	15	20150	46100	W1,W2,W3,W4,W5	Bulk
Cool White	C503B-WAN-CCaDb151	15	23500	46100	W1,W2,W3,W4,W5	Bulk
Cool White	C503B-WAN-CBbDb231	15	20150	46100	W2,W3	Bulk
Cool White	C503B-WAN-CCaDb341	15	23500	46100	W3,W4	Bulk
Cool White	C503B-WAN-CBbDb152	15	20150	46100	W1,W2,W3,W4,W5	Ammo
Cool White	C503B-WAN-CCaDb152	15	23500	46100	W1,W2,W3,W4,W5	Ammo
Cool White	C503B-WAN-CBbDb232	15	20150	46100	W2,W3	Ammo
Cool White	C503B-WAN-CCaDb342	15	23500	46100	W3,W4	Ammo

Notes:

- 1. The above kit numbers represent order codes that include multiple intensity-bin and color-bin codes. Only one intensity-bin code and one color-bin code will be shipped on each bulk. Single intensity-bin code and single color-bin codes will not be orderable.
- 2. Please refer to the "Cree LED Lamp Reliability Test Standards" document #1 for reliability test conditions.
- 3. Please refer to the "Cree LED Lamp Soldering & Handling" document *2 for information about how to use this LED product safely.

- #1: Refer to http://www.cree.com/led-components/media/documents/LED_Lamp_Reliability_Test_Standard.pdf
- #2: Refer to http://www.cree.com/led-components/media/documents/sh-HB.pdf



GRAPHS

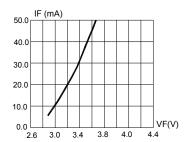


FIG.1 FORWARD CURRENT VS. FORWARD VOLTAGE.

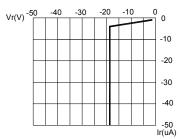
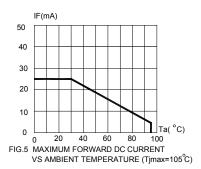


FIG.3 REVERSE CURRENT VS. REVERSE VOLTAGE.



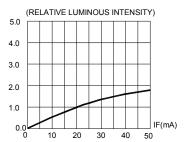


FIG.2 RELATIVE LUMINOUS INTENSITY VS. FORWARD CURRENT

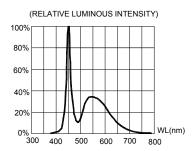
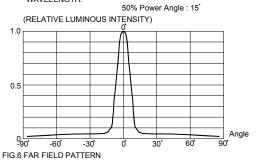


FIG.4 RELATIVE LUMINOUS INTENSITY VS. WAVELENGTH.



The above data are collected from statistical figures that do not necessarily correspond to the actual parameters of each single LED. Hence, these data will be changed without further notice.

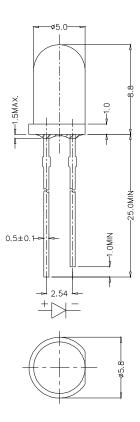


MECHANICAL DIMENSIONS

All dimensions are in mm. Tolerance is ±0.25 mm unless otherwise noted.

An epoxy meniscus may extend about 1.5 mm down the leads.

Burr around bottom of epoxy may be 0.5 mm max.



NOTES

RoHS Compliance

The levels of environmentally sensitive, persistent biologically toxic (PBT), persistent organic pollutants (POP), or otherwise restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2002/95/EC on the restriction of the use of certain hazardous substances in electrical and electronic equipment (RoHS), as amended through April 21, 2006.

Vision Advisory Claim

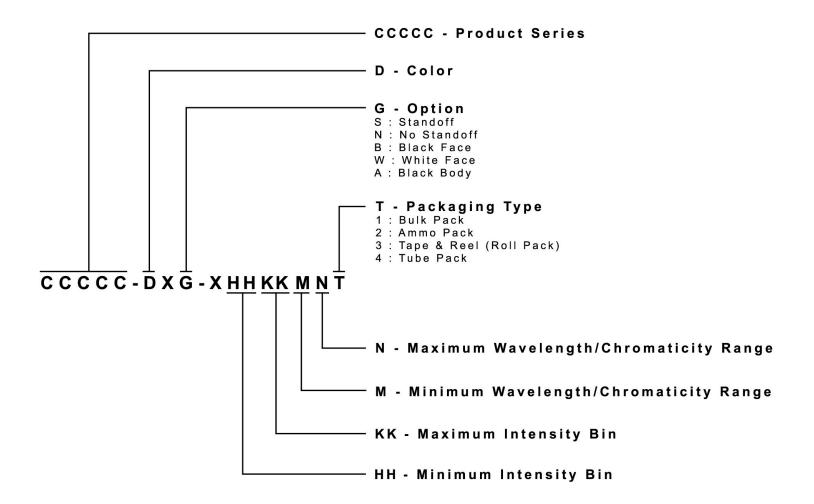
Users should be cautioned not to stare at the light of this LED product. The bright light can damage the eye.



KIT NUMBER SYSTEM

All dimensions in mm.Cree LED lamps are tested and sorted into performance bins. A bin is specified by ranges of color, forward voltage, and brightness. Sorted LEDs are packaged for shipping in various convenient options. Please refer to the "Cree LED Lamp Packaging Standard" document for more information about shipping and packaging options.

Cree LEDs are sold by order codes in combinations of bins called kits. Order codes are configured in the following manner:



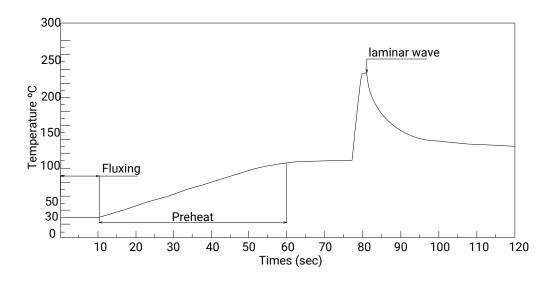


REFLOW SOLDERING

The LED soldering specification is shown below(suitable for both leaded solder & lead-free solder):

Manual Soldering		Solder Dipping		
Soldering iron	35 W max	Preheat	110 °C max	
Temperature	300 °C max	Preheat time	60 seconds max	
		Solder-bath temperature	260 °C Max	
Soldering time	3 seconds max	Dipping time	5 seconds max	
Position	Not less than 3 mm from the base of the package.	Position	Not less than 3 mm from the base of the package.	

- Manual soldering onto the PCB is not recommended because soldering time is uncontrollable.
- The recommended wave soldering is as below:



- Do not apply any stress to the LED package, particularly when heated.
- Only bottom preheat is suggested & should not preheat on top in order to reduce thermal stress experienced by the LEDs.
- The LEDs must not be re used once they have been extracted from PCB.
- After soldering the LEDs, the package should be protected from mechanical shock or vibration until the LEDs have reached 40 °C or below.
- Precautions must be taken as mechanical stress on the LEDs may be caused by PCB warpage or from the clinching and cutting of the LED leads.
- When it is necessary to clam the LEDs during soldering, it is important to ensure no mechanical stress is exerted on the LEDs.
- Cut the LED lead at normal room temperature. Lead cutting at high temperature may cause failure of the LEDs.

Refer to "http://www.cree.com/led-components/media/documents/sh-HB.pdf" for soldering & handling details.



PACKAGING

Features:

- The LEDs are packed in cardboard boxes after packaging in normal or anti-electrostatic bags.
- Cardboard boxes will be used to protect the LEDs from mechanical shock during transportation.
- The boxes are not water resistant, and they must be kept away from water and moisture.
- The Bulk Pack types of packaging.
- Max 500 pcs per bulk and Max 2500 pcs per ammo.

Bulk Pack Packaging Type:

Ammo Pack Packaging Type:

